Traditional High Q (>10,000) Low ESR Multi-Layer Ceramic Capacitors

2225C/P (0.220” x 0.250”)

Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 0.5pF to 2700pF
- Working Voltage: 2500V
- Extended Voltage: 3600V

Product Applications

Typical Functional Applications:

- Tuning • Bypass • Coupling
- Feedback • D.C. Blocking
- Impedance Matching

Typical Circuit Applications:

- UHF/Microwave RF Power Amplifiers
- Antenna Tuning • Plasma Chambers
- Medical Equipment

Marking shown for illustration purposes only. Actual marking may differ.

Part Numbering

2225	C	100	J	W	252	X	TV

- 2225: Case Size (0.220” x 0.250”)
- C: C = NP0, P = P90
- 100: Capacitor Code, 100=10x10⁰=10pF, 1R0=1.0pF
- J: Capacitance Tolerance *See Table*
- W: Termination Type *See Table*
- 252: Rated Voltage *See Table*
- X: Laser Marking
- TV: Add TV for Vertical Orientation

Capacitance Tolerance Codes

Code	A	B	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

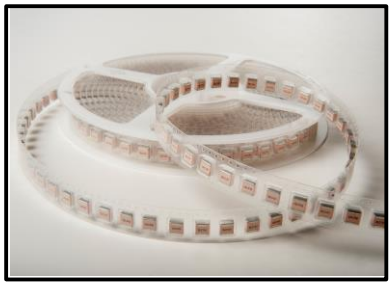
Voltage Codes

Voltage	Code	Voltage	Code
500V	501	2500V	252
1000V	102	3000V	302
1500V	152	3600V	362
2000V	202		

Traditional High Q (>10,000) Low ESR Multi-Layer Ceramic Capacitors

2225C/P (0.220” x 0.250”)

2225C/P Capacitance Values



- **NP0=C; P90=P**

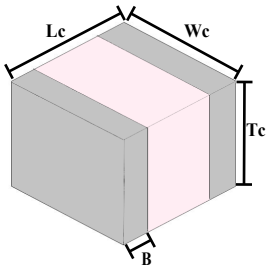
Special capacitances, tolerances and WVDC are available. Please contact PPI.

Cap. pF	Cap Code	Tol.	Rated WVDC Std.	Rated WVDC Ext.	Cap. pF	Cap Code	Tol.	Rated WVDC Std.	Rated WVDC Ext.	Cap. pF	Cap Code	Tol.	Rated WVDC Std.	Rated WVDC Ext.	Cap. pF	Cap Code	Tol.	Rated WVDC Std.	Rated WVDC Ext.
0.5	0R5	B,C, D	2500V	3600V	**4.3**	4R3	B,C, D	2500V	3600V	**43**	430	F,G, J,K	2500V	3600V	**430**	431	F,G, J,K	1500V	2000V
0.6	0R6				**4.7**	4R7				**47**	470				**470**	471			
0.7	0R7				**5.1**	5R1				**51**	510				**510**	511	F,G, J,K	1000V	1500V
0.8	0R8				**5.6**	5R6				**56**	560				**560**	561			
0.9	0R9				**6.2**	6R2				**62**	620				**620**	621			
1.0	1R0				**6.8**	6R8				**68**	680				**680**	681			
1.1	1R1				**7.5**	7R5				**75**	750				**750**	751			
1.2	1R2				**8.2**	8R2				**82**	820				**820**	821			
1.3	1R3				**9.1**	9R1				**91**	910				**910**	911			
1.4	1R4				**10**	100	F,G, J,K	2500V	3600V	**100**	101				**1000**	102			
1.5	1R5				**11**	110				**110**	111	F,G, J,K	2500V	3000V	**1100**	112			
1.6	1R6				**12**	120				**120**	121				**1200**	122			
1.7	1R7				**13**	130				**130**	131				**1500**	152	F,G, J,K	500V	N/A
1.8	1R8				**15**	150				**150**	151				**1800**	182			
1.9	1R9				**16**	160				**160**	161				**2200**	222			
2.0	2R0				**18**	180				**180**	181				**2700**	272			
2.1	2R1				**20**	200				**200**	201								
2.2	2R2				**22**	220				**220**	221								
2.4	2R4				**24**	240				**240**	241								
2.7	2R7				**27**	270				**270**	271								
3.0	3R0				**30**	300				**300**	301	F,G, J,K	1500V	2000V					
3.3	3R3				**33**	330				**330**	331								
3.6	3R6				**36**	360				**360**	361								
3.9	3R9				**39**	390				**390**	391								

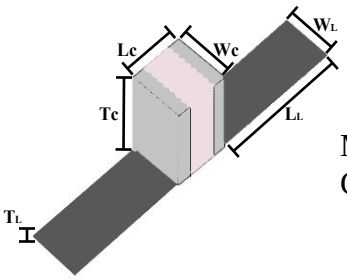
Traditional High Q (>10,000) Low ESR Multi-Layer Ceramic Capacitors

2225C/P (0.220” x 0.250”)

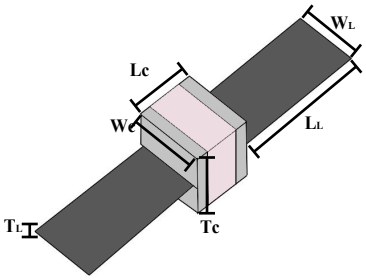
Termination Types and Codes



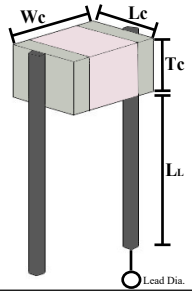
Chip Termination:
Codes: W, L, P



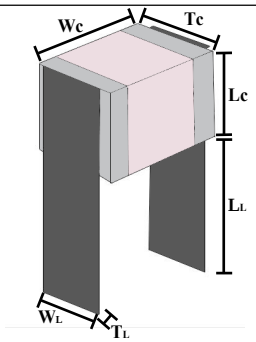
Microstrip Termination:
Codes: MS, MN



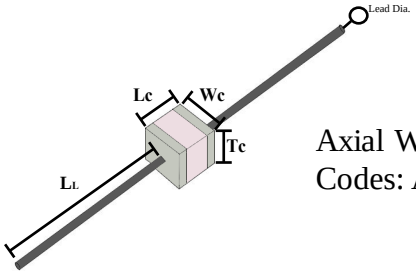
Axial Ribbon Termination:
Code: AR, AN



Radial Wire Termination:
Codes: RW, RN



Radial Ribbon Termination:
Code: RR, FN



Axial Wire Termination:
Codes: AW, BN

Termination Code	Magnetic Termination
W	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
MS	Silver-Plated Copper
AR	
RR	
RW	
AW	

Termination Code	Non-Magnetic Termination
P	100% Tin Solder over Copper Barrier
MN	Silver-Plated Copper
AN	
FN	
RN	
BN	

Note: “Non-Magnetic” means no magnetic materials.

Traditional High Q (>10,000) Low ESR Multi-Layer Ceramic Capacitors

2225C/P (0.220" x 0.250")

Dimensions - For Termination Types images, see previous page

Unit: inch (millimeter)

Code		Magnetic Termination Capacitor Dimensions Length Lc	Width Wc	Thickness Tc	Overlap B	Lead Dimensions Length LL	Width WL	Thickness TL
W/L	Chip	0.225 +0.025 -0.010 (5.72 +0.64 -0.25)	0.250 ± 0.015 (6.35 ± 0.38)	0.165 max (4.19 max)	0.020 ~ 0.047 (0.50 ~ 1.20)	-	-	-
MS	Microstrip	0.245 ± 0.025 (6.22 ± 0.64)	0.250 ± 0.015 (6.35 ± 0.38)	0.150 max (3.81 max)	-	0.500 min (12.70 min)	0.240 ± 0.005 (6.1 ± 0.13)	0.008 ± 0.001 (0.2 ± 0.025)
AR	Axial Ribbon							
RR	Radial Ribbon					0.354 min (9.00 min)	0.118 ± 0.005 (3.00 ± 0.13)	0.012 ± 0.001 (0.3 ± 0.025)
RW	Radio Wire					0.709 min (18.00 min)	Dia. = 0.031 ± 0.004	
AW	Axial Wire					0.906 min (23.00 min)	Dia. = (0.80 ± 0.10)	

Code		Non-Magnetic Termination Capacitor Dimensions Length Lc	Width Wc	Thickness Tc	Overlap B	Lead Dimensions Length LL	Width WL	Thickness TL
P	Chip	0.225 +0.025 -0.010 (5.72 +0.64 -0.25)	0.250 ± 0.015 (6.35 ± 0.38)	0.165 max (4.19 max)	0.020 ~ 0.047 (0.50 ~ 1.20)	-	-	-
MN	Microstrip	0.245 ± 0.025 (6.22 ± 0.64)	0.250 ± 0.015 (6.35 ± 0.38)	0.150 max (3.81 max)	-	0.500 min (12.70 min)	0.240 ± 0.005 (6.1 ± 0.13)	0.008 ± 0.001 (0.2 ± 0.025)
AN	Axial Ribbon							
FN	Radial Ribbon					0.354 min (9.00 min)	0.118 ± 0.005 (3.00 ± 0.13)	0.012 ± 0.001 (0.3 ± 0.025)
RN	Radio Wire					0.709 min (18.00 min)	Dia. = 0.031 ± 0.004	
BN	Axial Wire					0.906 min (23.00 min)	Dia. = (0.80 ± 0.10)	

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.

Traditional High Q (>10,000) Low ESR Multi-Layer Ceramic Capacitors

2225C/P (0.220” x 0.250”)

Electrical Specifications

Quality Factor (Q)	Greater than 10,000 at 1 MHz
Insulation Resistance (IR)	Test Voltage: 500V 10^5 Megaohms min. @ +25°C 10^4 Megaohms min. @ +125°C
Rated Voltage	See Rated Voltage in Capacitance Table
Dielectric Withstanding Voltage (DWV)	250% of Rated Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <Rated Voltage ≤ 1250 VDC 120% of Voltage for 5 seconds, Rated Voltage > 1250 VDC
Operating Temperature Range	-55°C to 200°C
Temperature Coefficient (TC)	C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: -55°C to 200°C +90±20ppm/°C
Capacitance Drift	±0.02% or ±0.02pF, whichever is greater
Piezoelectric Effects	None
Termination Type	See Termination Type Table

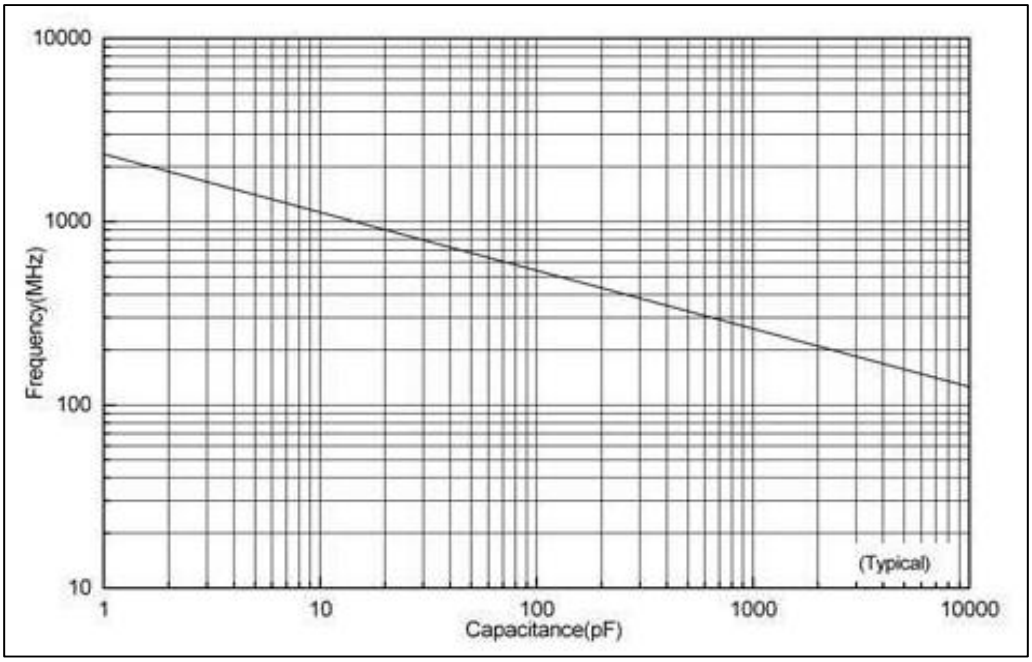
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

Environmental Specifications

	Specification	Test Parameters
Thermal Shock	**DWV:** The initial Value **IR:** Shall not be less than 30% of the initial value. **Capacitance Change:** No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance		MIL-STD-202, Method 106
Humidity (Steady State)	**DWV:** The initial Value **IR:** The initial value. **Capacitance Change:** No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	**IR:** Shall not be less than 30% of the initial value. **Capacitance Change:** No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Strength	**Force:** 20lbs typical, 10lbs. Minimum. **Duration Time:** 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.

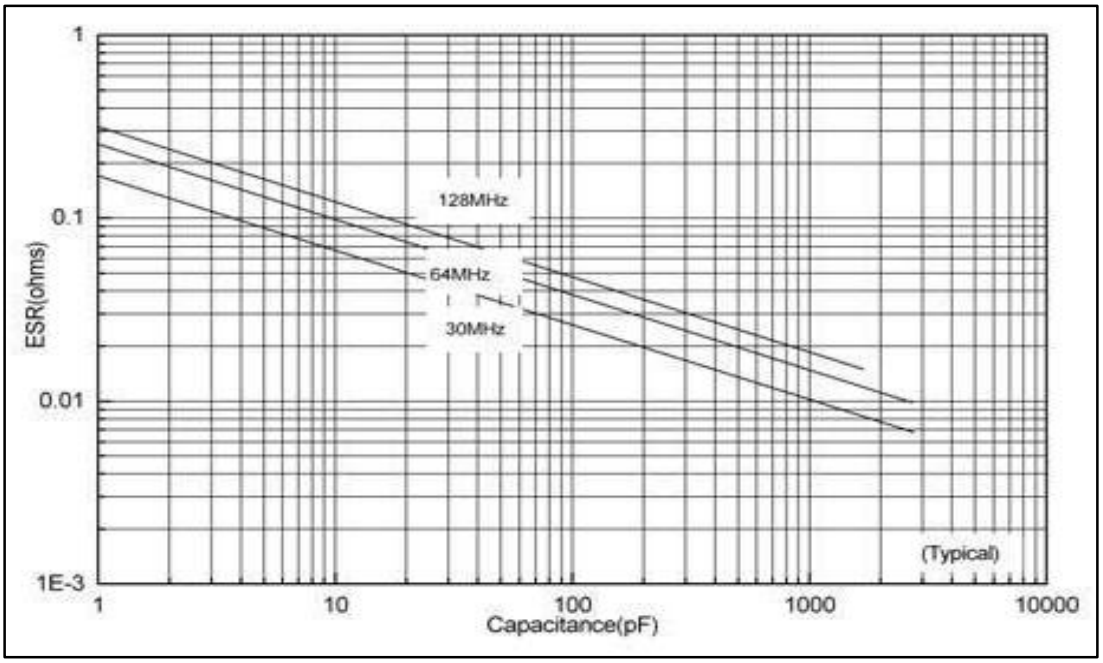
Series Resonance vs. Capacitance

Series Resonance vs. Capacitance



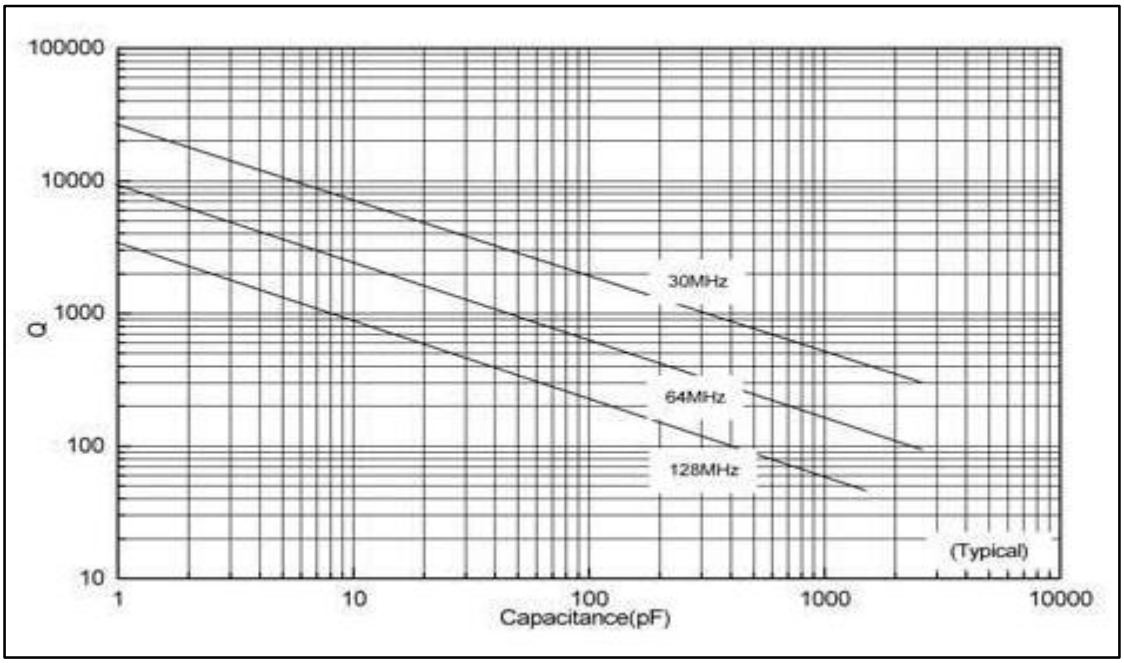
ESR vs. Frequency

2225C/P ESR vs Frequency



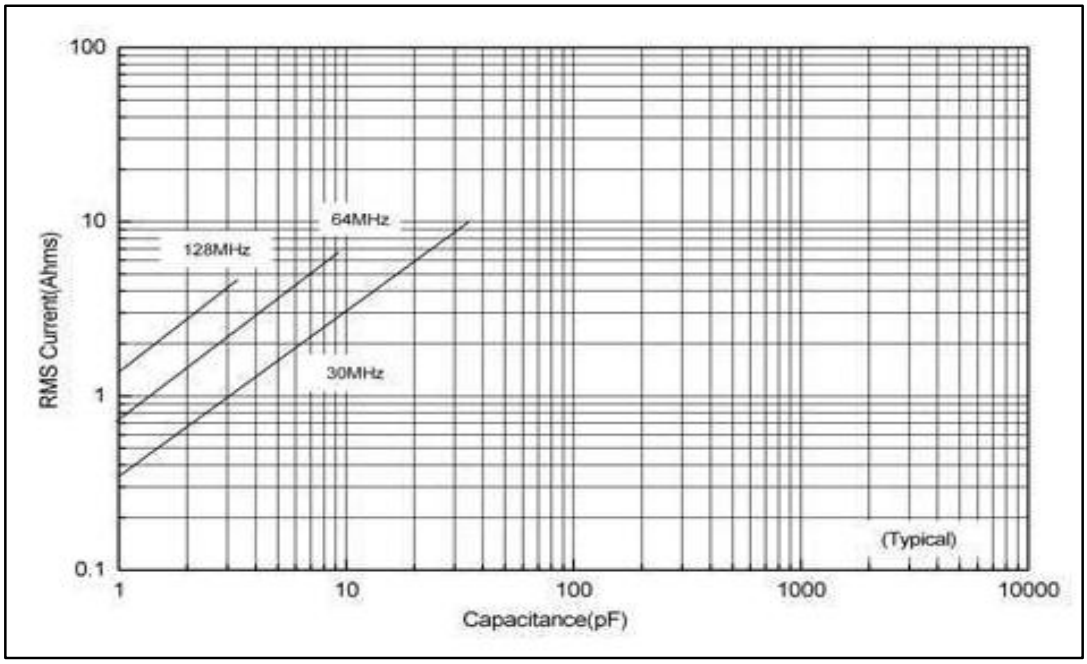
Q vs. Capacitance

Q vs Capacitance



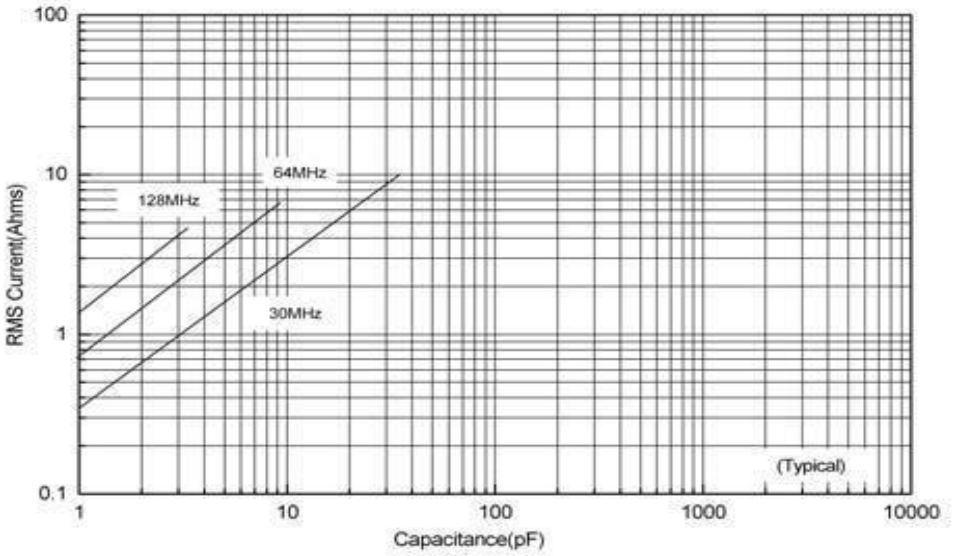
Current Rating vs. Capacitance

2225C/P Current Rating vs Capacitance



Current Rating vs. Capacitance

2225C/P Current Rating vs Capacitance



Current limits can depend on two different criteria. The first Voltage Limited Current ($I_{volt\ lim}$, represented by the solid line), the second is Power Dissipation Limited Current ($I_{pow\ diss}$).

$$I_{volt\ lim} = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_C} = \sqrt{2}\pi FCV_{rated}$$

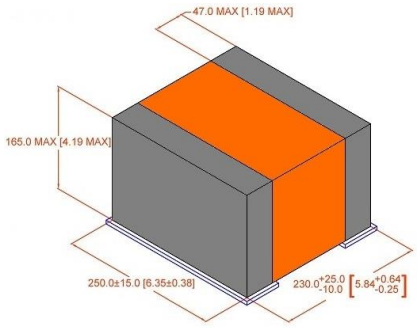
$I_{pow\ diss} = \sqrt{\frac{P_{dissipation}}{ESR}}$ (If the thermal resistance of the mounting surface is 15°C/W, then you will reach the power dissipated limit of 4W)

Traditional High Q (>10,000) Low ESR Multi-Layer Ceramic Capacitors

2225C/P (0.220” x 0.250”)

Capacitor Application Program

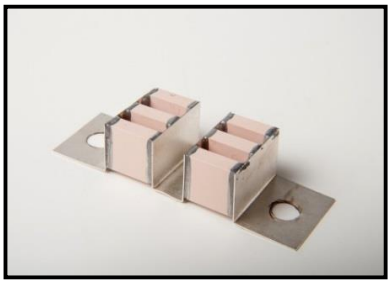
PPI’s brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

Custom Assemblies

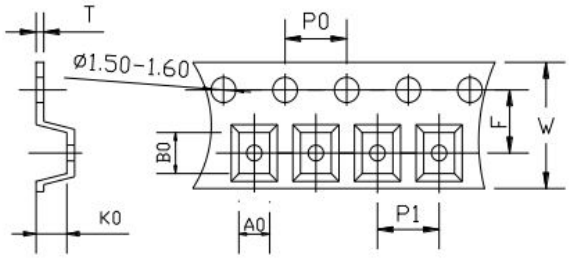


Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% up-screened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.

Tape & Reel Specifications (mm)

Orientation	Measurement Unit	W	P0	P1	T	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
H	in.	0.630	0.157	0.472	0.012	0.295	500	500	Plastic
	mm	16.00	4.00	12.00	0.30	7.50			
V	in.	0.630	0.157	0.315	0.020	0.295	500	500	Plastic
	mm	16.00	4.00	8.00	0.50	7.50			



$A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.